



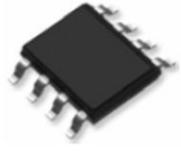
## GENERAL FEATURES

- $V_{DS} = -30V$   $I_D = -60A$
- $R_{DS(ON)} < 11\text{ m}\Omega$  @  $V_{GS}=10V$

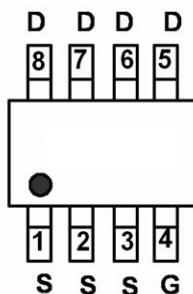
## Application

- Load/Power Switching
- Interfacing Switching
- Logic Level Shift

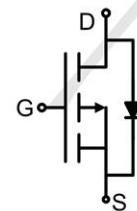
## Package and Pin Configuration



SOP-8 top view



## Circuit diagram



## Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Rating		Units
		10s	Steady State	
$V_{DS}$	Drain-Source Voltage	-30		V
$V_{GS}$	Gate-Source Voltage	$\pm 20$		V
$I_D@T_C=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ $-10V^1$	-15		A
$I_D@T_C=100^\circ C$	Continuous Drain Current, $V_{GS}$ @ $-10V^1$	-12		A
$I_D@T_A=25^\circ C$	Continuous Drain Current, $V_{GS}$ @ $-10V^1$	-14.3	-9	A
$I_D@T_A=70^\circ C$	Continuous Drain Current, $V_{GS}$ @ $-10V^1$	-11.4	-7.2	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	-130		A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	125		mJ
IAS	Avalanche Current	-50		A
$P_D@T_C=25^\circ C$	Total Power Dissipation <sup>4</sup>	37		W
$P_D@T_A=25^\circ C$	Total Power Dissipation <sup>4</sup>	4.2	1.67	W
TSTG	Storage Temperature Range	-55 to 150		°C
$T_J$	Operating Junction Temperature Range	-55 to 150		°C

**Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$	-30	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BVDSS Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$	---	-0.0232	---	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{\text{GS}}=-10\text{V}$ , $I_D=-10\text{A}$	---	---	11	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_D=-8\text{A}$	---	---	20	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D = -250\mu\text{A}$	-1.2	---	-2.5	V
$\Delta V_{\text{GS}(\text{th})}$	$V_{\text{GS}(\text{th})}$ Temperature Coefficient		---	4.6	---	$\text{mV}/^\circ\text{C}$
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=-24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	-1	$\text{uA}$
		$V_{\text{DS}}=-24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=55^\circ\text{C}$	---	---	-5	
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=-5\text{V}$ , $I_D=-30\text{A}$	---	30	---	S
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	9	---	$\Omega$
$Q_g$	Total Gate Charge (-4.5V)	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=-4.5\text{V}$ , $I_D=-15\text{A}$	---	22	---	$\text{nC}$
$Q_{\text{gs}}$	Gate-Source Charge		---	8.7	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	7.2	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DD}}=-15\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $R_G=3.3$ , $I_D=-15\text{A}$	---	8	---	$\text{ns}$
$T_r$	Rise Time		---	73.7	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	61.8	---	
$T_f$	Fall Time		---	24.4	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-15\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	2215	---	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		---	310	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	237	---	
$I_s$	Continuous Source Current <sup>1,5</sup>	$V_G=V_D=0\text{V}$ , Force Current	---	---	-42	A
$I_{\text{SM}}$	Pulsed Source Current <sup>2,5</sup>		---	---	-130	A
$V_{\text{SD}}$	Diode Forward Voltage <sup>2</sup>	$V_{\text{GS}}=0\text{V}$ , $I_s=-1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	-1	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=-15\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	19	---	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		---	9	---	nC

### Typical Electrical and Thermal Characteristics

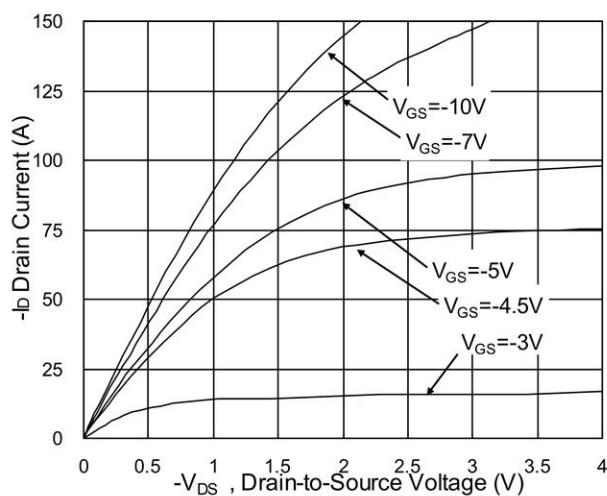


Fig.1 Typical Output Characteristics

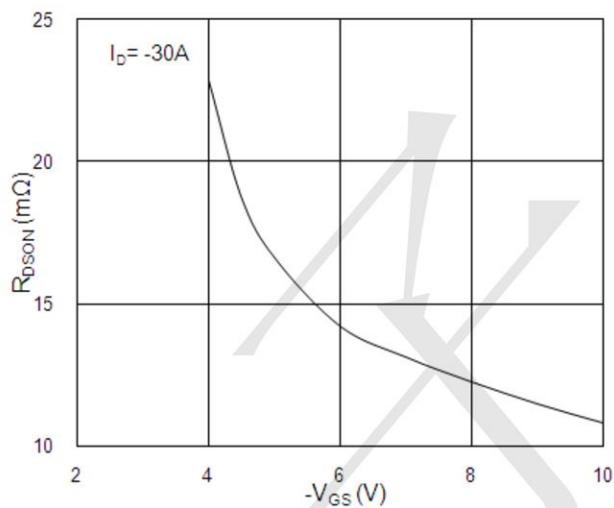


Fig.2 On-Resistance vs. G-S Voltage

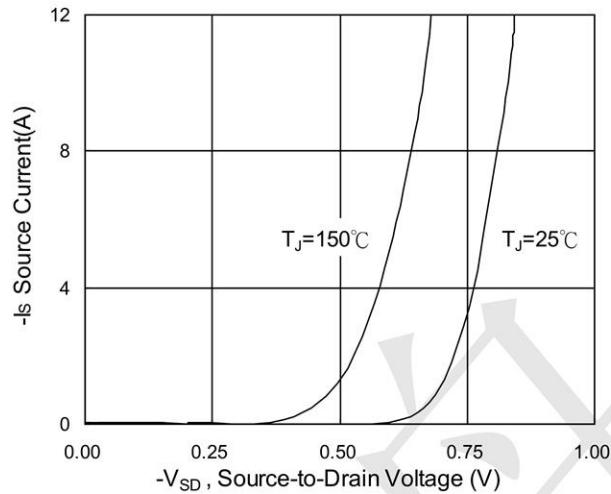


Fig.3 Forward Characteristics of Reverse

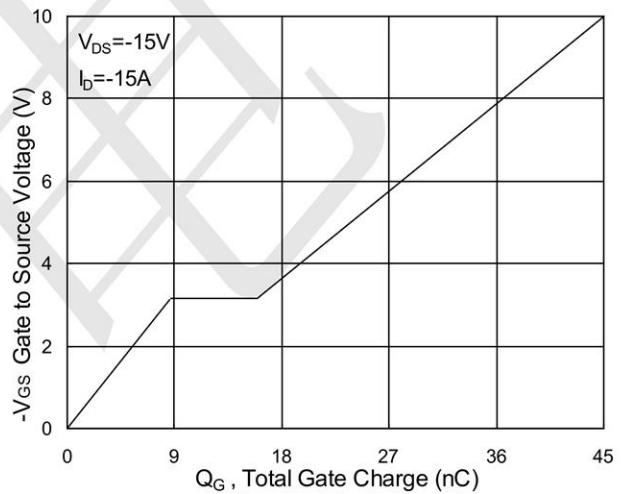


Fig.4 Gate-Charge Characteristics

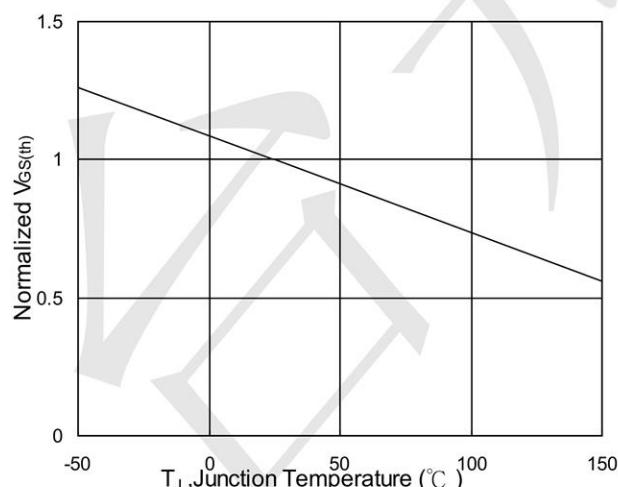


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$

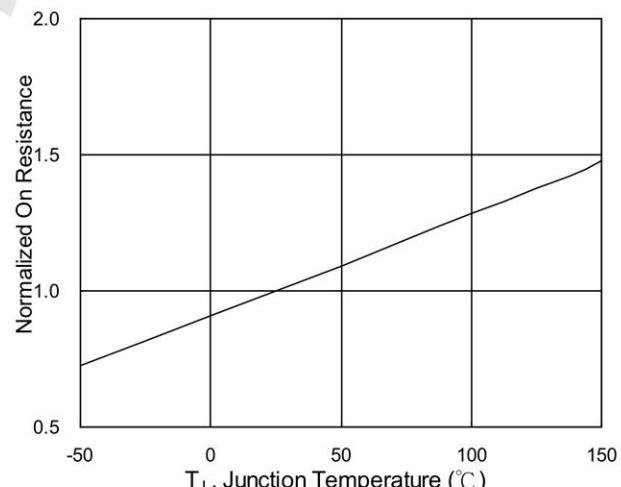


Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$

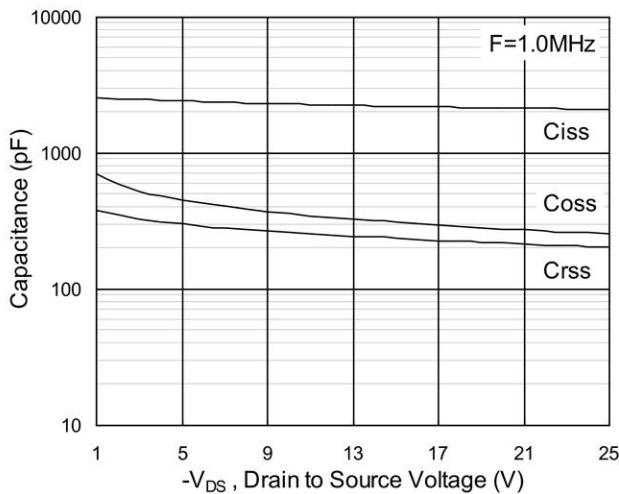


Fig.7 Capacitance

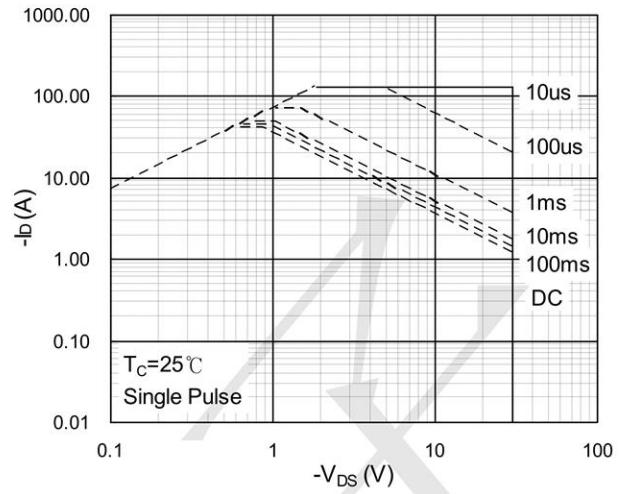


Fig.8 Safe Operating Area

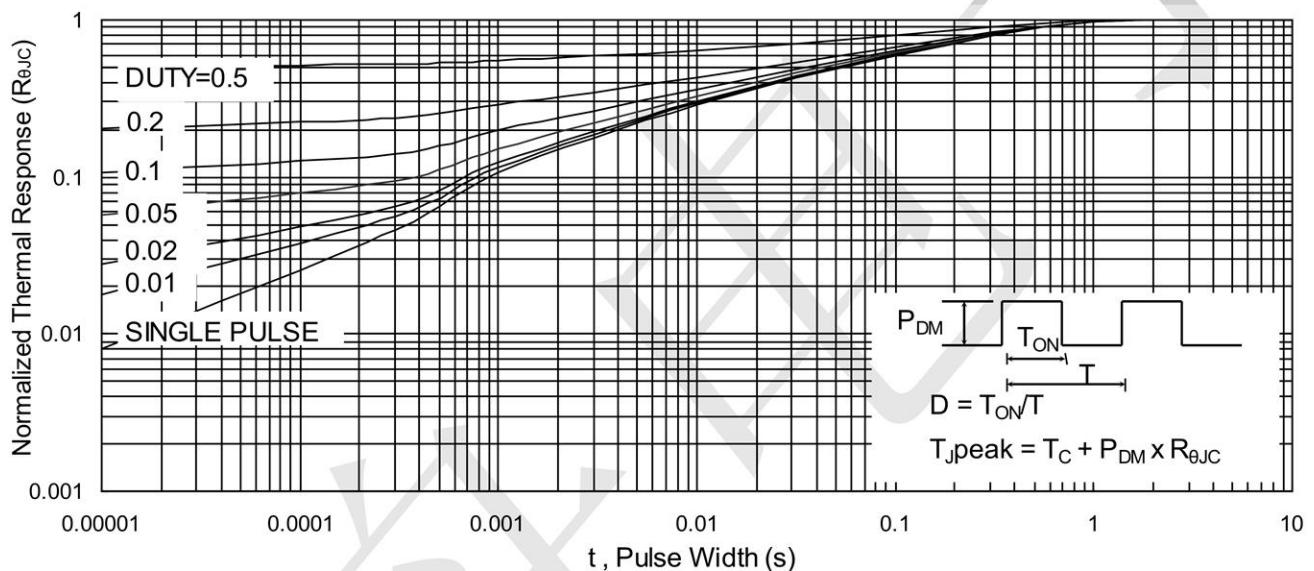


Fig.9 Normalized Maximum Transient Thermal Impedance

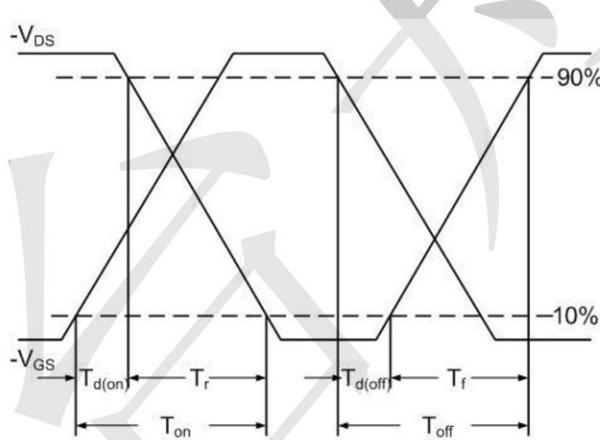


Fig.10 Switching Time Waveform

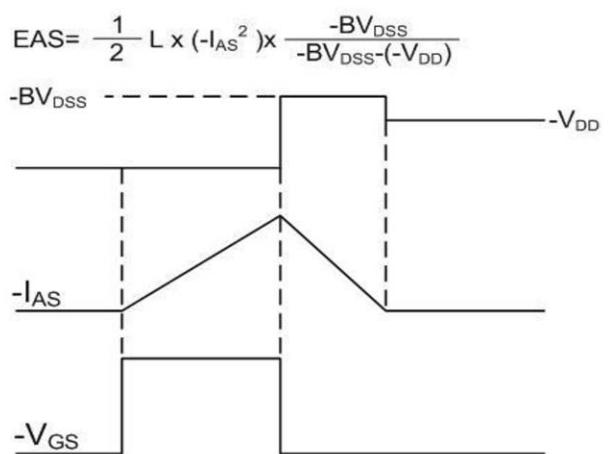
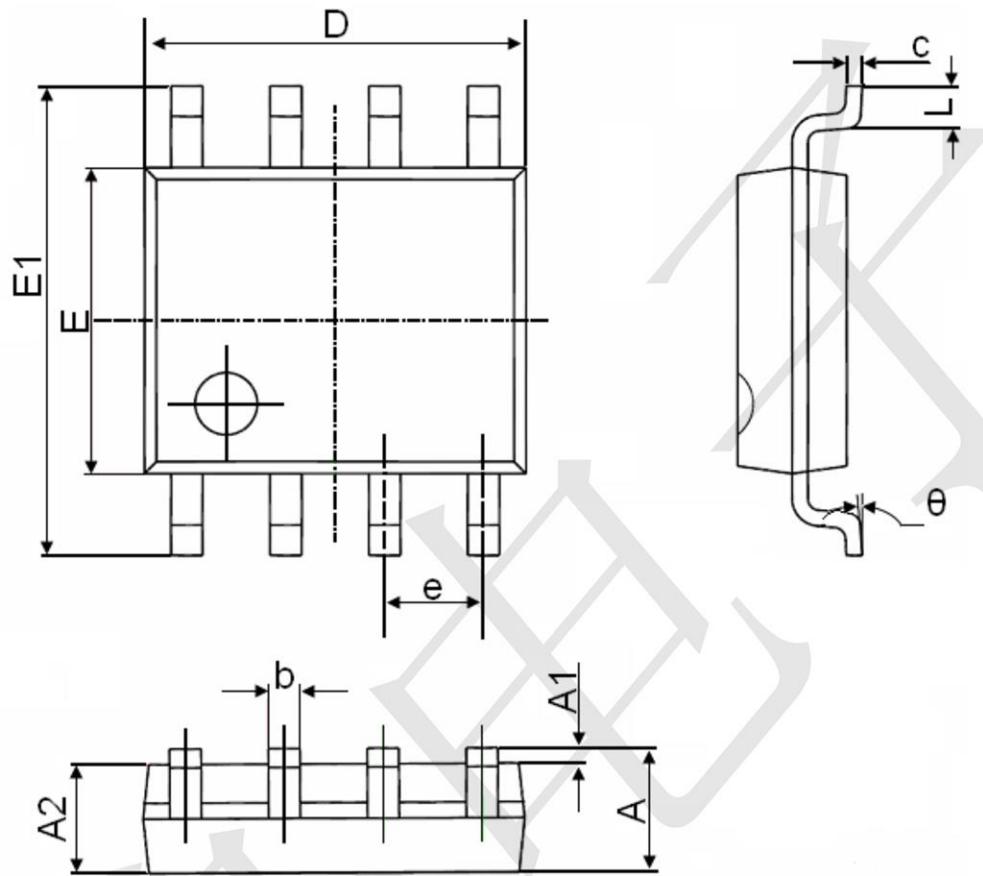


Fig.11 Unclamped Inductive Switching Waveform

**SOP-8 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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